

## *H-Bridge Motor Driver/Amplifier*



### FEATURES

- Low Cost Complete H-Bridge
- Self-contained Smart Lowside/ Highside Drive Circuitry Wide Supply Range: Up to 80V
- 10A Continuous Output
- Isolated Case Allows Direct Heatsinking
- Four Quadrant Operation, Torque Control Capability
- Internal/Programmable PWM
- Frequency Generation



### APPLICATIONS

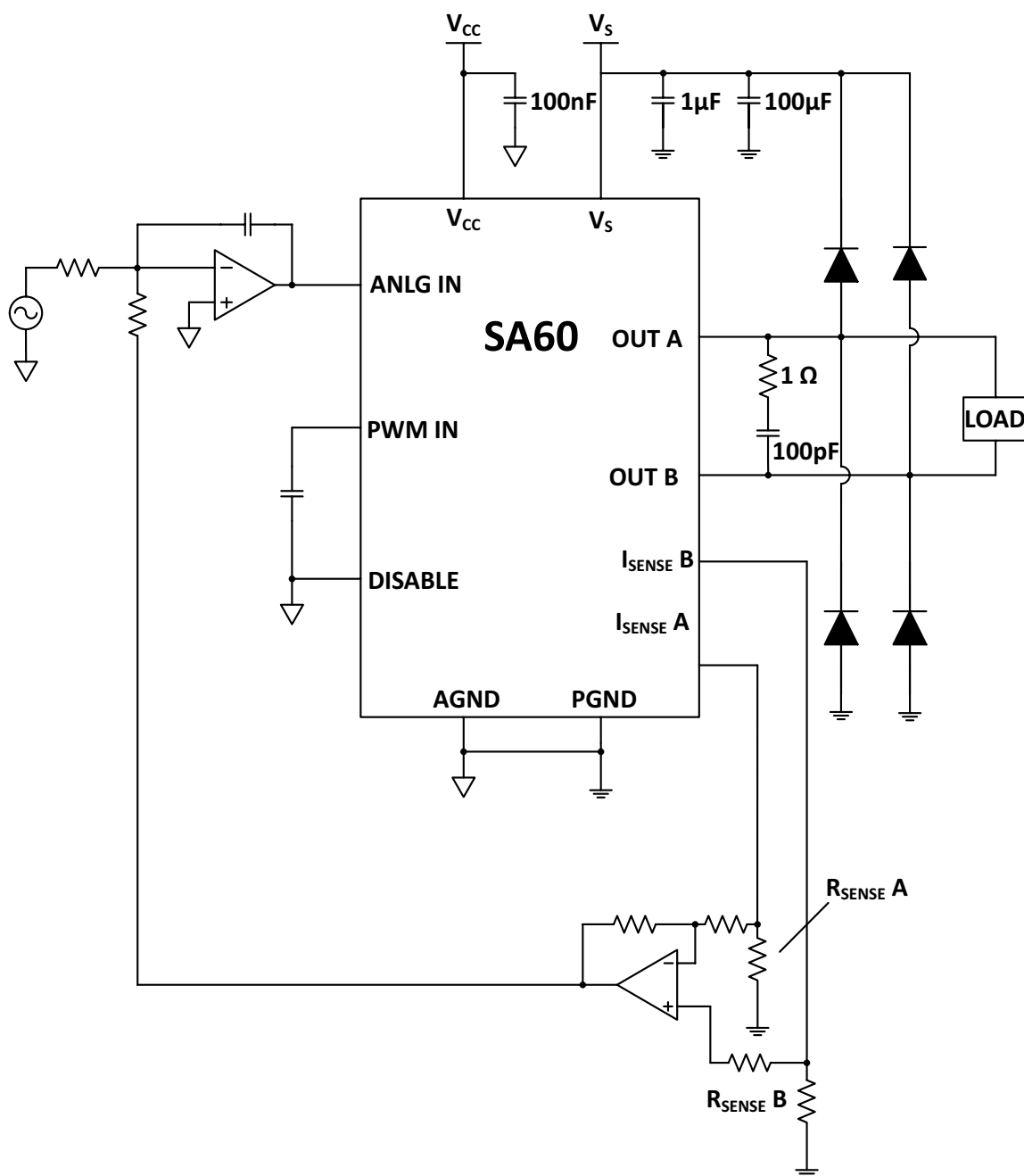
- Brush Type Motor Control
- Class D Switchmode Amplifier
- Reactive Loads
- Magnetic Coils (MRI)
- Active Magnetic Bearing
- Vibration Canceling

### DESCRIPTION

The SA60 is a pulse width modulation amplifier that can supply 10A continuous current to the load. The full bridge amplifier can be operated over a wide range of supply voltages. All of the drive/control circuitry for the lowside and highside switches are internal to the hybrid. The PWM circuitry is internal as well, leaving the user to only provide an analog signal for the motor speed/direction, or audio signal for switchmode audio amplification. The internal PWM frequency can be programmed by an external integrator capacitor. Alternatively, the user may provide an external TTL-compatible PWM signal for simultaneous amplitude and direction control for four quadrant mode.

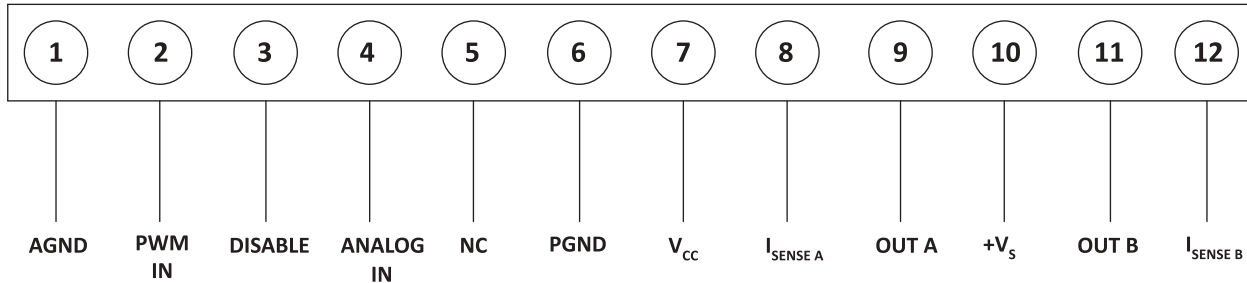
## TYPICAL CONNECTION

Figure 1: Typical Connection



## PINOUT AND DESCRIPTION TABLE

Figure 2: External Connections



Pin Number	Name	Description
1	AGND	Analog ground and reference for the internal PWM oscillator. Connect to pin 6 with a single conductor.
2	PWM IN	TTL compatible PWM input. A duty cycle greater than 50% will produce greater than 50% duty cycle pulses on OUT A. A duty cycle less than 50% will produce greater than 50% duty cycle on OUT B. For analog inputs, the capacitor for the internal clock must be connected between this pin and AGND.
3	DISABLE	Logic high at this pin will disable all outputs. If left open, an internal pullup to V <sub>cc</sub> will keep DISABLE high. When taken low, all outputs function normally.
4	ANLG IN	Analog input. A voltage higher than V <sub>cc</sub> /2 will produce greater than 50% duty cycle pulses on OUT B. A voltage lower than V <sub>cc</sub> /2 will produce greater than 50% duty cycle pulses on OUT A. If using in the digital mode, bias this point at 1/2 the logic high level.
5	NC	No connection.
6	PGND	Power ground. Connect V <sub>s</sub> power supply ground, filters, and bypass capacitors. Connect to pin 1 with a single conductor.
7	V <sub>cc</sub>	Voltage supply for logic circuit. Connect 12 V supply. The ground terminal of the supply must be connected to AGND.
8	I <sub>SENSE A</sub>	Connect R <sub>SENSE A</sub> between I <sub>SENSE A</sub> and PGND to monitor the current. All current from half-bridge A flows out of this pin from the load.
9	OUT A	The "A" terminal of the output. Connect this pin to one end of the load, opposite B.
10	V <sub>s</sub>	The supply rail.
11	OUT B	The "B" terminal of the output. Connect this pin to one end of the load, opposite A.
12	I <sub>SENSE B</sub>	Connect R <sub>SENSE B</sub> between I <sub>SENSE B</sub> and PGND to monitor the current. All current from half-bridge B flows out of this pin from the load.

## PIN DESCRIPTION

**V<sub>CC</sub>** - is the low voltage supply for powering internal logic and drivers for the low side and high side MOSFETS.

The supplies for the high side drivers are derived from this voltage.

**V<sub>S</sub>** - is the higher voltage H-bridge supply. The MOSFETS obtain the output current from this supply pin. The voltage on this pin is limited to +80V by the drive IC. The MOSFETS are rated at 100 volts.

**ISENSE A & B** - These are tied to power GND directly or through sense resistors.

**Analog GND** - is the reference for the internal PWM oscillator. Connect this pin to pin 6. Connect low side of V<sub>CC</sub> supply and any other supply used to generate analog input signals to ANALOG GND.

**Analog Input** - is an analog input for controlling the PWM pulse width of the bridge. A voltage higher than V<sub>CC</sub>/2 will produce greater than 50% duty cycle pulses out of B OUT. A voltage lower than V<sub>CC</sub>/2 will produce greater than 50% duty cycle pulses out of A OUT. If using in the digital mode, bias this point at 1/2 the logic high level.

**Disable** - Is the connection for disabling all 4 output switches. DISABLE high overrides all other inputs. When taken low, everything functions normally. An internal pull up to V<sub>CC</sub> will keep DISABLE high if pin left open.

**PWM Input** - Is the TTL compatible digital input for controlling the PWM pulse width of the bridge. A duty cycle greater than 50% will produce greater than 50% duty cycle pulses out of the A out. A duty cycle less than 50% will produce greater than 50% duty cycle from the B out. For analog inputs, the integration capacitor for the internal clock must be connected between this pin and analog ground. The internal switching frequency is programmable up to 125 kHz by selection of the integration capacitor.

The formula is:

$$C_C(pF) = \left( \frac{1.44 \times 10^7}{F_{SW}} \right) - 50$$

## SPECIFICATIONS

All Min/Max characteristics and specifications are guaranteed over the Specified Operating Conditions. Typical performance characteristics and specifications are derived from measurements taken at typical supply voltages and  $T_C = 25^\circ\text{C}$ ,  $V_{CC} = 12\text{VDC}$

### ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Units
Supply Voltage, total <sup>1</sup>	$+V_S$ to $-V_S$		80	V
Output Current, peak	$I_O$		15	A
Logic Supply Voltage	$V_{CC}$		16	V
Power Dissipation, internal <sup>2</sup>	$P_D$		156	W
Temperature, pin solder, 10s max.			260	$^\circ\text{C}$
Temperature, junction <sup>3</sup>	$T_J$		150	$^\circ\text{C}$
Temperature Range, storage		-55	125	$^\circ\text{C}$
Operating Temperature Range, case	$T_C$	-40	85	$^\circ\text{C}$

1. Derate to 70V below  $T_C = +25^\circ\text{C}$

2. Each of the two active output transistors can dissipate 78W.

3. Long term operation at the maximum junction temperature will result in reduced product life. Derate power dissipation to achieve high MTTF.

### CAUTION

The SA60 is constructed from MOSFET transistors. ESD handling procedures must be observed. The exposed substrate contains beryllia (BeO). Do not crush, machine, or subject to temperatures in excess of  $850^\circ\text{C}$  to avoid generating toxic fumes.

### INPUT

Parameter	Test Conditions	Min	Typ	Max	Units
Analog Input Voltages	$V_{CC} = 12\text{V}$				
A,B OUT = 50% Duty Cycle			$1/2 V_{CC}$		VDC
A OUT = 100% Duty Cycle High			$1/3 V_{CC}$		VDC
B OUT = 100% Duty Cycle High			$2/3 V_{CC}$		VDC
PWM Input					
PWM Pulse Low Voltage		0		0.8	VDC
PWM Pulse High Voltage		2.7		5.0	VDC
PWM Frequency			45	250	kHz
Disable On		2.7		$V_{CC}$	VDC
Disable Off		0		0.8	VDC

**OUTPUT**

Parameter	Test Conditions	Min	Typ	Max	Units
$V_{DS}$ (ON) Voltage, each MOSFET	$I_{DS} = 10A$		1.7	2.5	VDC
Total $R_{ON}$ , both MOSFETs				0.45	$\Omega$
Efficiency, 10A Output	$+V_S = 80A$		91		%
Current, Continuous		10			A
Current, peak	$t = 100$ msec	15			A
Switching Frequency	$C_F = 270pF$		45		kHz
Dead Time			90		ns

**POWER SUPPLY**

Parameter	Test Conditions	Min	Typ	Max	Units
$+V_S$ Voltage <sup>1</sup>	$+V_S$ Current = Load Current			80	VDC
$V_{CC}$ Voltage		9.5	12	15	VDC
$V_{CC}$ Current, quiescent	$V_{CC} = 12VDC$		28	36	mA
$+V_S$ Current, quiescent	Switching Freq. = 45 kHz, no load, $V_S = 50V$		45		mA

1. Derate to 70V below  $T_C = +25^\circ C$ .

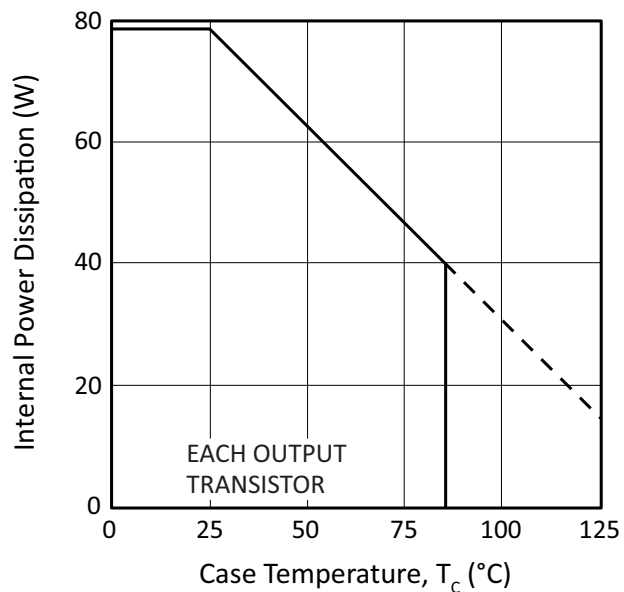
**THERMAL**

Parameter <sup>1</sup>	Test Conditions	Min	Typ	Max	Units
Resistance, junction to case	Full temp range, for each transistor			1.6	$^\circ C/W$
Resistance, junction to air	Full temp range		30		$^\circ C/W$
Temperature Range, case		-25		+85	$^\circ C$

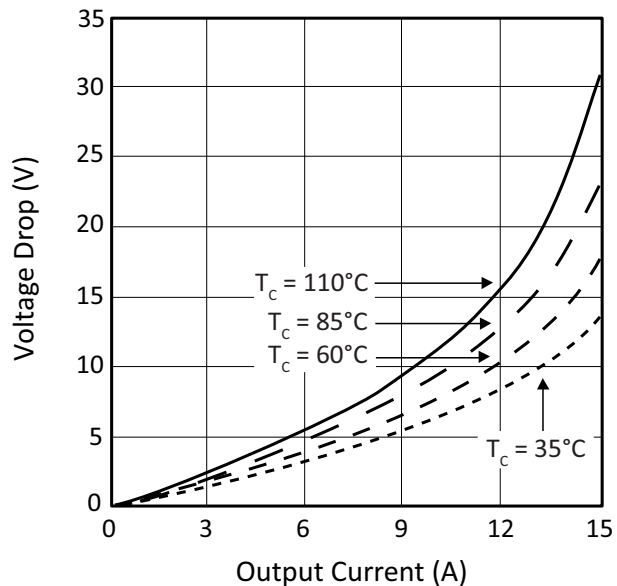
1. Each of the two active output transistors can dissipate 78W.

## TYPICAL PERFORMANCE GRAPHS

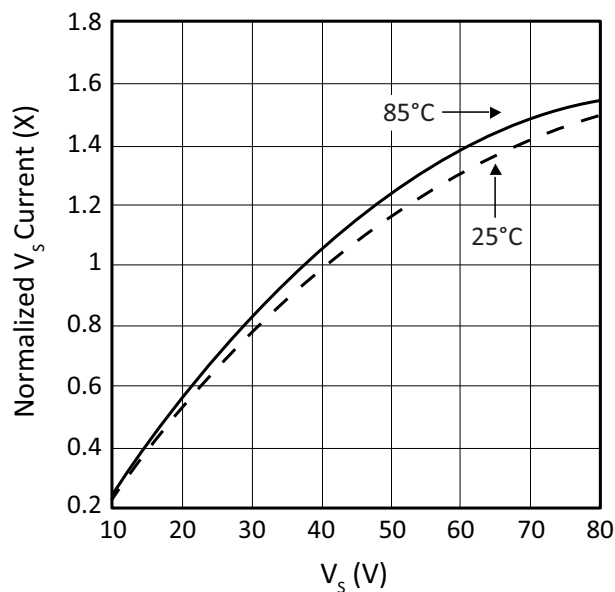
**Figure 3: Power Derating**



**Figure 4: Total Voltage Drop**



**Figure 5:  $V_s$  Quiescent vs. Voltage**



**Figure 6:  $V_{CC}$  Quiescent vs. Voltage**

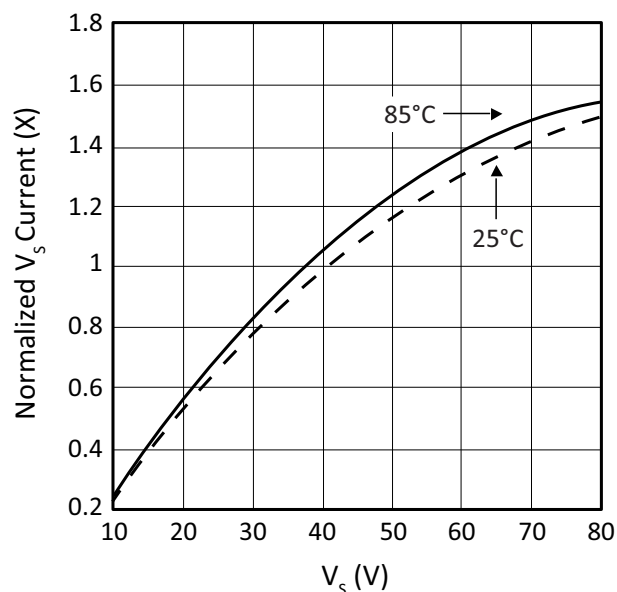


Figure 7: Duty Cycle vs. Analog Input

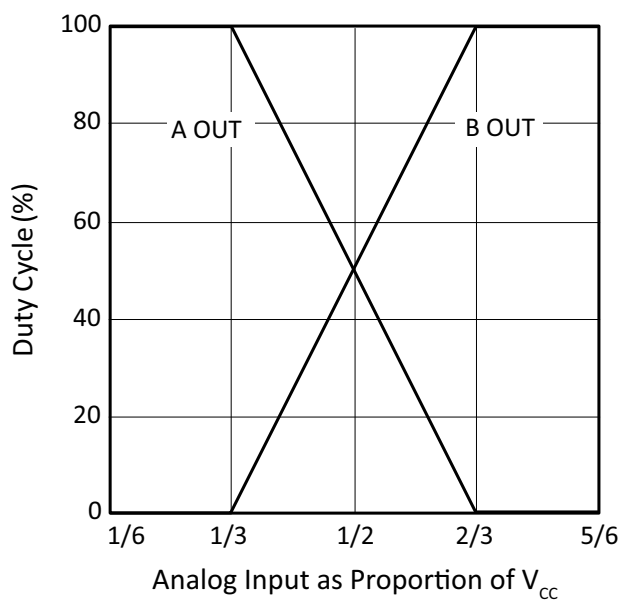


Figure 8: Reverse Diodes

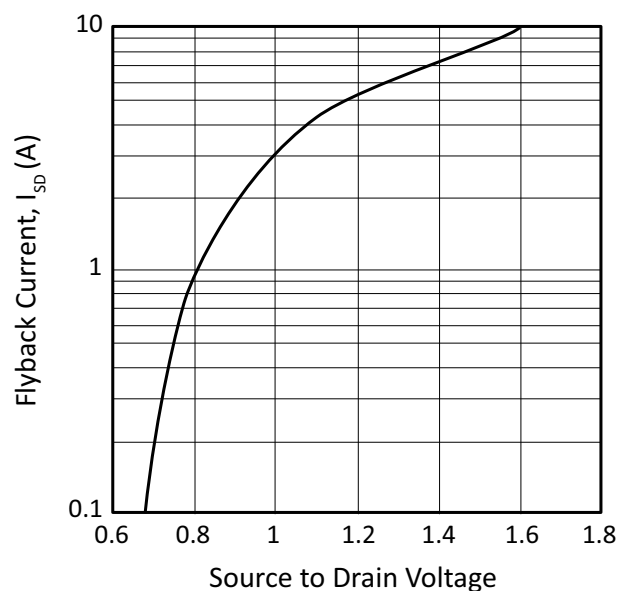


Figure 9:  $V_s$  Quiescent vs. Switch Frequency

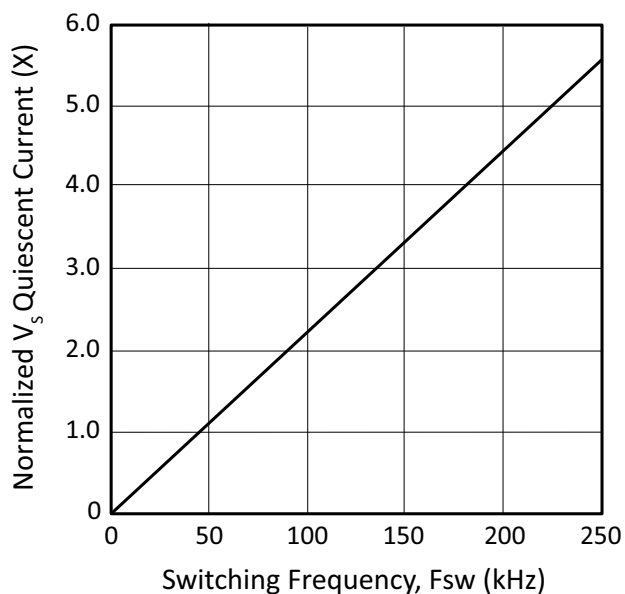
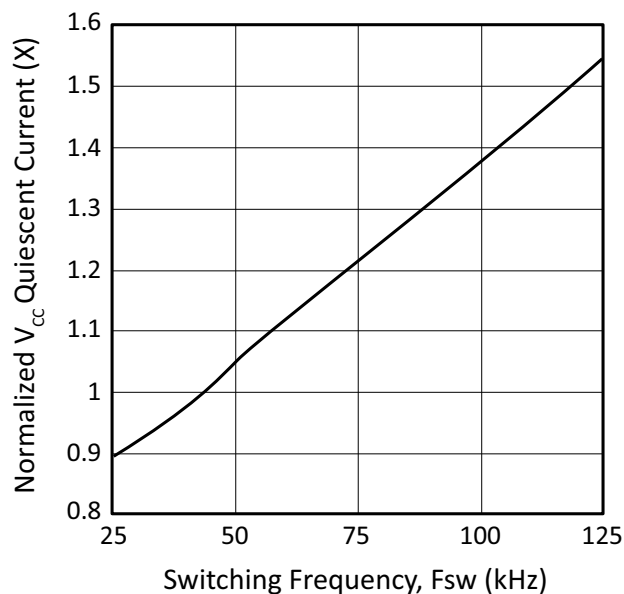
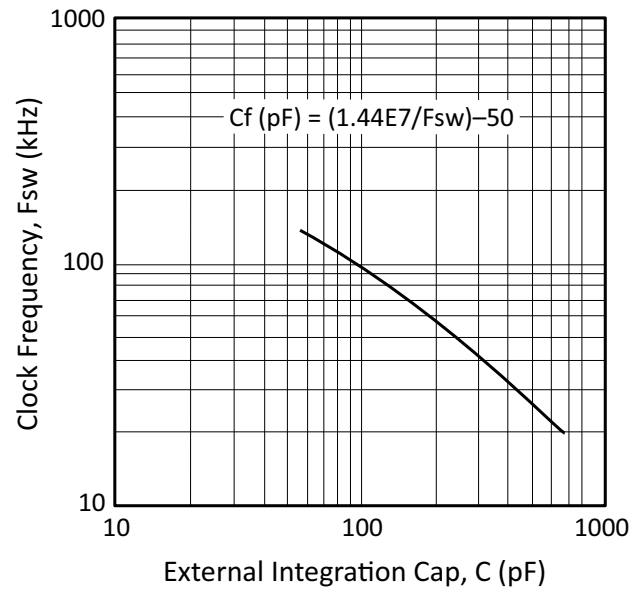


Figure 10:  $V_{CC}$  Quiescent vs. Switch Frequency





**Figure 11: PWM Frequency vs.  
External Integration Capacitor**



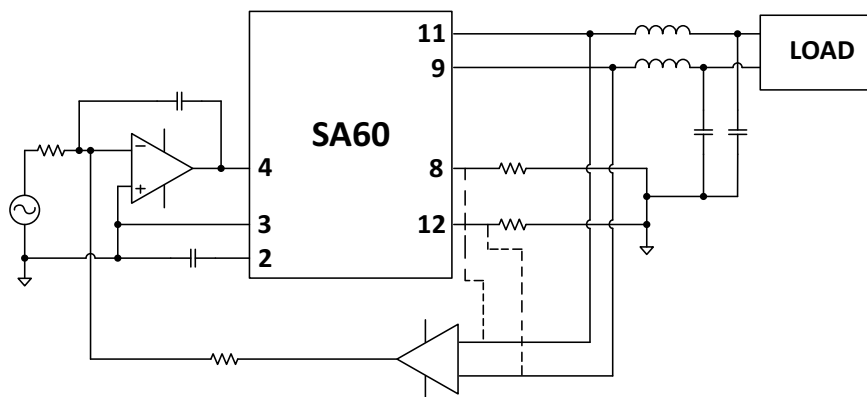
## GENERAL

Please read Application Note 30 “PWM Basics.” Refer to Application Note 1 “General Operating Considerations” which covers stability, supplies, heat sinking, mounting, current limit, SOA interpretation, and specification interpretation. Visit [www.apexanalog.com](http://www.apexanalog.com) for Apex Microtechnology’s complete Application Notes library, Technical Seminar Workbook, and Evaluation Kits.

## TYPICAL APPLICATION

A wide variety of loads can be driven in either the voltage mode or the current mode. The most common applications use three external blocks: a low pass filter converting pulse width data to an analog output, a difference amplifier to monitor voltage or current and an error amplifier. Filter inductors must be suitable for square waves at the switching frequency (laminated steel is generally not acceptable). Filter capacitors must be low ESR and rated for the expected ripple current. A difference amplifier with gain of less than one translates the differential output voltage to a single feedback voltage. Dashed line connections and a higher gain difference amplifier would be used for current control. The error amplifier integrates the difference between the input and feedback voltages to close the loop.

Figure 12: Typical Application



## PWM OSCILLATOR – INTERNAL OR EXTERNAL

The SA60 contains an internal PWM oscillator whose frequency is determined by an external capacitor connected between pin 1 and pin 2. Maximum frequency is 125 kHz. The user may also disregard the internal PWM oscillator and supply the SA60 with an external TTL pulse generator up to 250 kHz.

## BYPASSING

Adequate bypassing of the power supplies is required for proper operation. Failure to do so can cause erratic and low efficiency operation as well as excessive ringing at the outputs. The  $V_s$  supply should be bypassed with at least a  $1\mu\text{F}$  ceramic capacitor in parallel with another low ESR capacitor of at least  $10\mu\text{F}$  per amp of output current. Capacitor types rated for switching applications are the only types that should be considered. The  $1\mu\text{F}$  ceramic capacitor must be physically connected directly to the  $V_s$  and POWER GND pins. Even one inch of lead length will cause excessive ringing at the outputs. This is due to the very fast switching times and the inductance of the lead connection. The bypassing requirements of the  $V_{cc}$  supply are less stringent, but still necessary. A  $0.1\mu\text{F}$  to  $0.47\mu\text{F}$  ceramic capacitor connected directly to the  $V_{cc}$  and ANALOG GND pins will suffice.

## **PCB LAYOUT**

The designer needs to appreciate that the SA60 combines in one circuit both high speed high power switching and low level analog signals. Certain layout rules of thumb must be considered when a circuit board layout is designed using the SA60:

1. Bypassing of the power supplies is critical. Capacitors must be connected directly to the power supply pins with very short lead lengths (well under 1 inch). Ceramic chip capacitors are best.
2. Connect ANALOG GND to POWER GND with a conductor having no intermediate connections. Connect all Vs power supply, filter and load related ground connections to POWER GND keeping these conductors separate until reaching pin 6. Connect all Vcc power supply and input signal related ground connections to ANALOG GND keeping conductors separate until reaching pin 1. Do not allow ground loops to form by making additional ground connections at the low side of the physical power supplies. If ground plane is used do not allow more than 1mA to flow through it.
3. Beware of capacitive coupling between output connections and signal inputs through the parasitic capacitance between layers in multilayer PCB designs.
4. Do not run small signal traces between the pins of the output section (pins 8-12).

## **CURRENT SENSE**

There are two load current sensing pins, I SENSE A and I SENSE B. The two pins can be shorted to POWER GND in the voltage mode connection but both must be used in the current mode connection. It is recommended that R SENSE resistors be non-inductive. Load current flows in the I SENSE pins. The SA60 has no internal current limit.

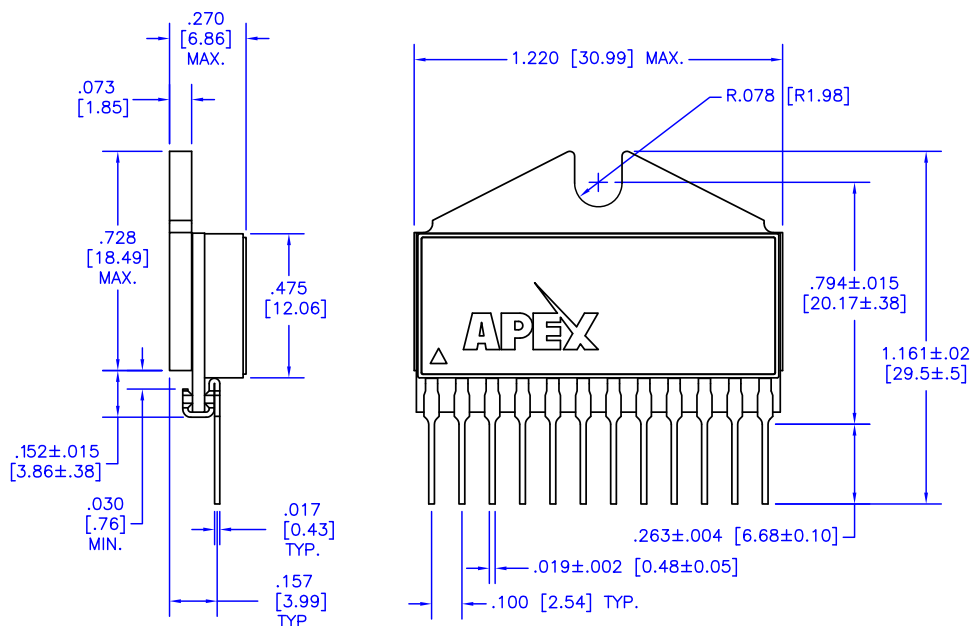
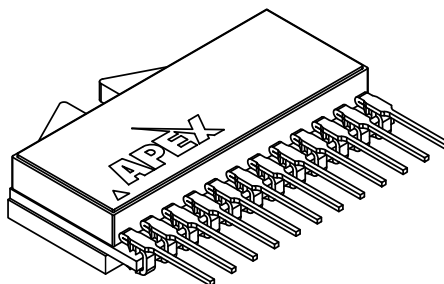
## **TRANSIENT SUPPRESSION**

An RC network of a 100 pF Capacitor and a one ohm resistor is required as shown in the typical connection diagram on page 2. This network assures proper operation under various loads. Minimal power is dissipated in the resistor.

## PACKAGE OPTIONS

Part Number	Apex Package Style	Description
SA60DP	DP	12-Pin SIP
SA60DPA	DP	12-Pin SIP
SA160EE	EE	12-Pin SIP w/ formed leads
SA160EEA	EE	12-Pin SIP w/ formed leads
SA160/31	FP	12-Pin SIP w/ formed leads

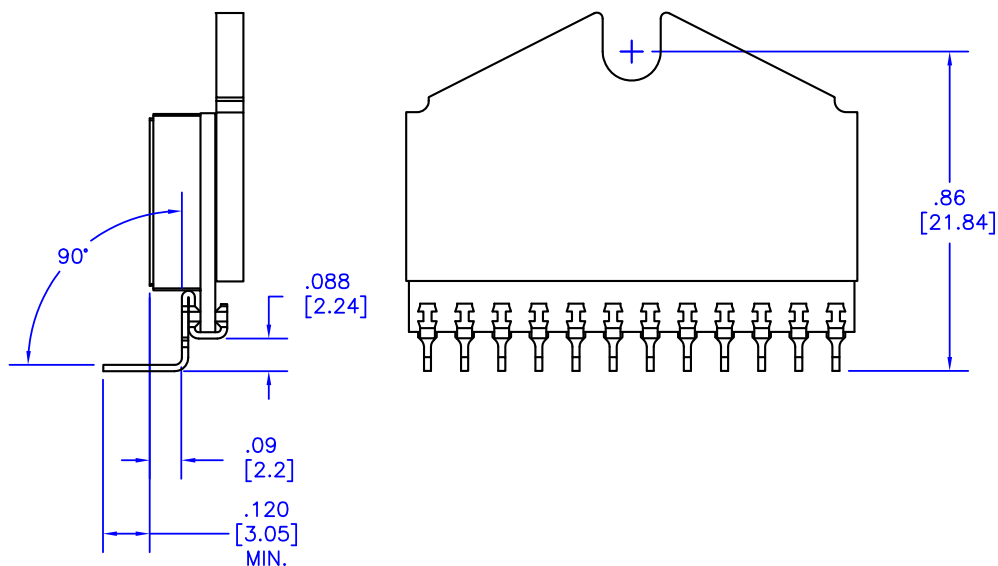
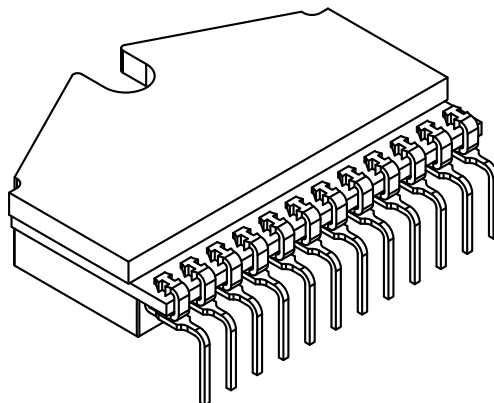
### PACKAGE STYLE DP



#### NOTES:

1. Dimensions are inches & [mm].
2. Triangle on lid denotes pin 1.
3. Pins: Alloy 510 phosphor bronze plated with matte tin (150 – 300μ") over nickel (50 μ" max.) underplate.
4. Package: Vectra liquid crystal polymer, black
5. Epoxy-sealed & ultrasonically welded non-hermetic package.
6. Package weight: .367 oz. [11.41 g]

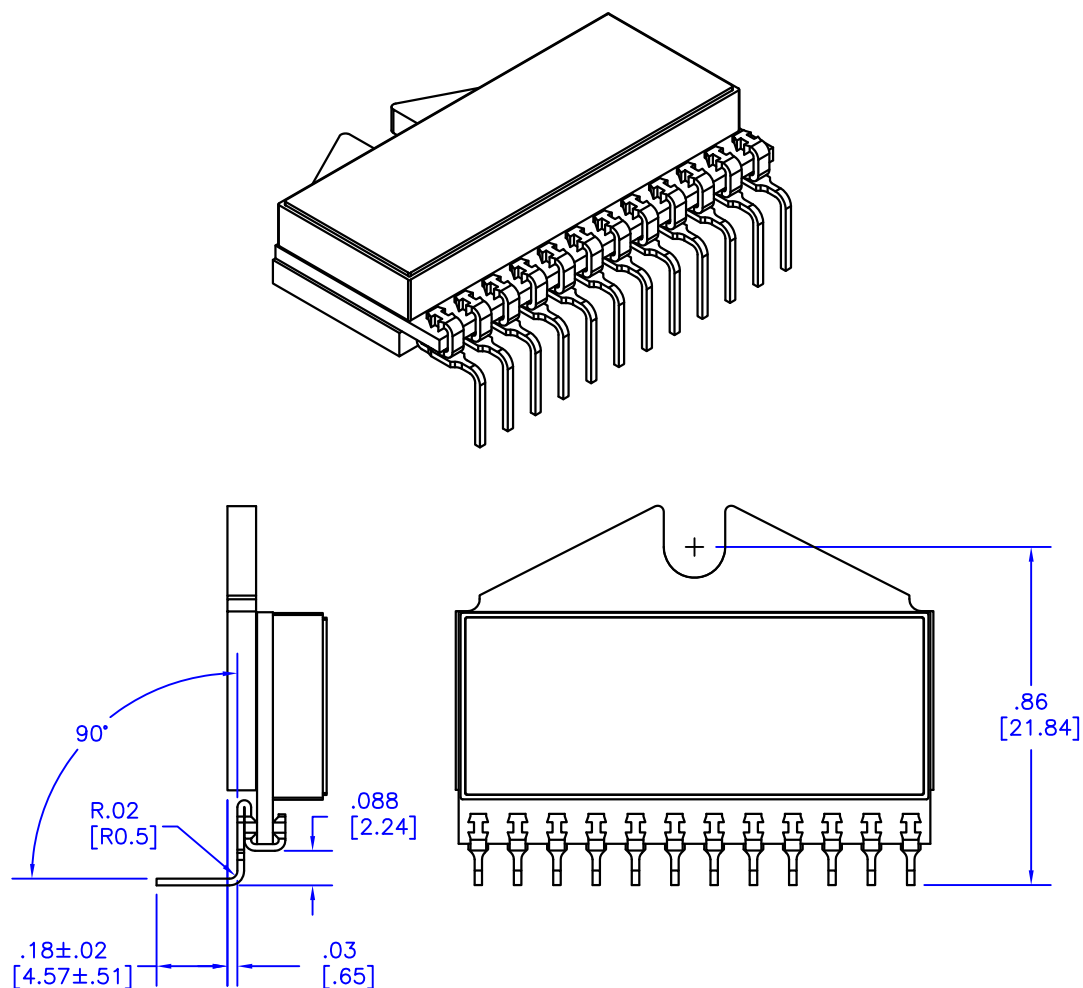
**PACKAGE STYLE EE**



**NOTES:**

1. Dimensions are inches & [mm].
2. For other dimensions and information on this package with unformed leads, see package DP.

## PACKAGE STYLE FP



### NOTES:

1. Dimensions are inches & [mm].
2. For other dimensions and information on this package with unformed leads, see package DP.

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